NOTES:
2. CONTROLLING DIMENSION: MILLIMETERS
3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.
4. 463C−01 OBSOLETE, NEW STANDARD 463C−02.

<table>
<thead>
<tr>
<th>XX = Specific Device Code</th>
<th>D = Date Code</th>
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<tbody>
<tr>
<td>X</td>
<td>Y</td>
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</tbody>
</table>

**Generic Marking Diagram**

*This information is generic. Please refer to device data sheet for actual part marking.

Pb-Free indicator, “G” or microdot “*”, may or may not be present. Some products may not follow the Generic Marking.